DATA SHEET

For a complete data sheet, please also download:

- The IC06 74HC/HCT/HCU/HCMOS Logic Family Specifications
- The IC06 74HC/HCT/HCU/HCMOS Logic Package Information
- The IC06 74HC/HCT/HCU/HCMOS Logic Package Outlines

74HC/HCT574

Octal D-type flip-flop; positive edge-trigger; 3-state

Product specification
File under Integrated Circuits, IC06

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Philips Semiconductors

PHILIPS

Octal D-type flip-flop; positive edge-trigger; 3-state

74HC/HCT574

FEATURES

- 3-state non-inverting outputs for bus oriented applications
- 8-bit positive edge-triggered register
- Common 3-state output enable input
- Independent register and 3-state buffer operation
- Output capability: bus driver
- I_{CC} category: MSI

GENERAL DESCRIPTION

The 74HC/HCT574 are high-speed Si-gate CMOS devices and are pin compatible with low power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74HC/HCT574 are octal D-type flip-flops featuring separate D-type inputs for each flip-flop and non-inverting 3-state outputs for bus oriented applications. A clock (CP) and an output enable ($\overline{OE}$) input are common to all flip-flops.

The 8 flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH CP transition.
When $\overline{OE}$ is LOW, the contents of the 8 flip-flops are available at the outputs.
When $\overline{OE}$ is HIGH, the outputs go to the high impedance OFF-state.
Operation of the $\overline{OE}$ input does not affect the state of the flip-flops.

The “574” is functionally identical to the “564”, but has non-inverting outputs.
The “574” is functionally identical to the “374”, but has a different pinning.

QUICK REFERENCE DATA

GND = 0 V; T_{amb} = 25 °C; $t_r = t_f$ = 6 ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL		UNIT
			HC	HCT	
t_{PHL}/ t_{PLH}	propagation delay CP to Q_n	C_L = 15 pF; V_{CC} = 5 V	14	15	ns
f_{max}	maximum clock frequency		123	76	MHz
C_I	input capacitance		3.5	3.5	pF
C_{PD}	power dissipation capacitance per flip-flop	notes 1 and 2	22	25	pF

Notes

1. C_{PD} is used to determine the dynamic power dissipation (P_D in µW):

   $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

   f_i = input frequency in MHz

   f_o = output frequency in MHz

   $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs

   C_L = output load capacitance in pF

   V_{CC} = supply voltage in V

2. For HC the condition is V_I = GND to V_{CC}
   For HCT the condition is V_I = GND to V_{CC} – 1.5 V

ORDERING INFORMATION

See *“74HC/HCT/HCU/HCMOS Logic Package Information”*.

PIN DESCRIPTION

PIN NO.	SYMBOL	NAME AND FUNCTION
1	$\overline{OE}$	3-state output enable input (active LOW)
2, 3, 4, 5, 6, 7, 8, 9	D_0 to D_7	data inputs
10	GND	ground (0 V)
11	CP	clock input (LOW-to-HIGH, edge-triggered)
19, 18, 17, 16, 15, 14, 13, 12	Q_0 to Q_7	3-state flip-flop outputs
20	V_{CC}	positive supply voltage

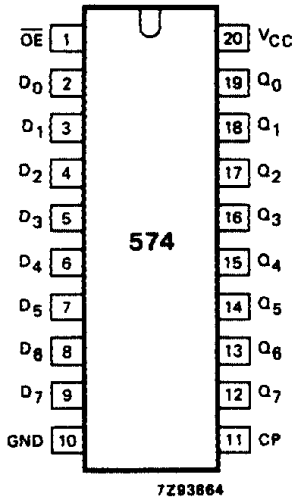


Fig.1 Pin configuration.

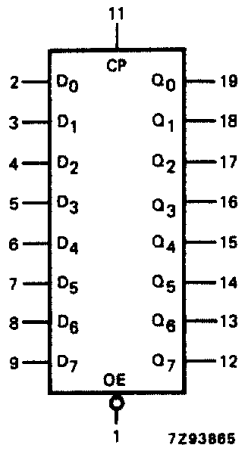


Fig.2 Logic symbol.

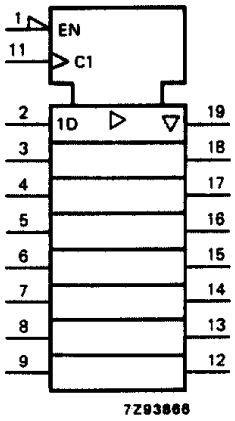


Fig.3 IEC logic symbol.

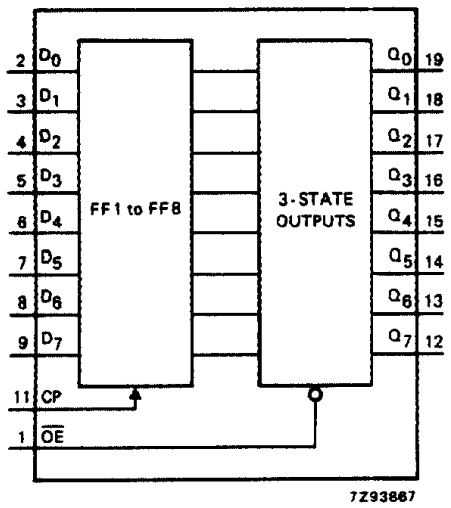


Fig.4 Functional diagram.

FUNCTION TABLE

OPERATING MODES	INPUTS			INTERNAL FLIP-FLOPS	OUTPUTS
	$\overline{OE}$	CP	D_n		Q_0 to Q_7
load and read register	L L	↑ ↑	l h	L H	L H
load register and disable outputs	H H	↑ ↑	l h	L H	Z Z

Notes

1. H = HIGH voltage level
   h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition
   L = LOW voltage level
   l = LOW voltage level on set-up time prior to the LOW-to-HIGH CP transition
   Z = HIGH impedance OFF-state
   ↑ = LOW-to-HIGH clock transition

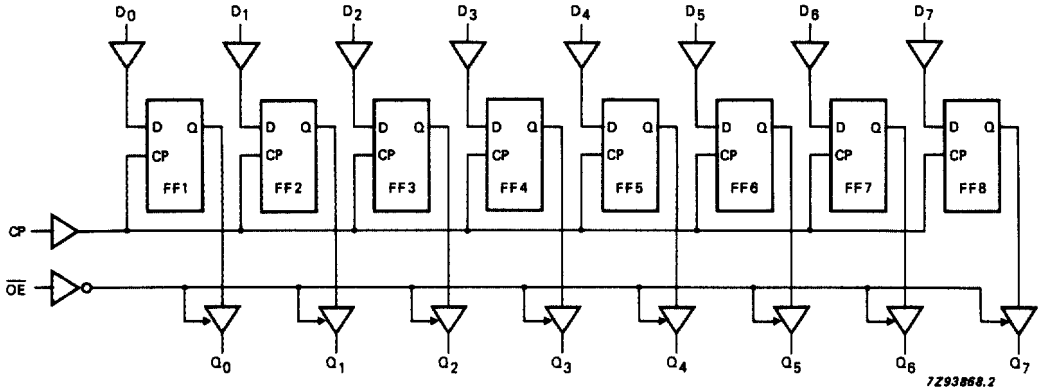


Fig.5 Logic diagram.

DC CHARACTERISTICS FOR 74HC

For the DC characteristics see *"74HC/HCT/HCU/HCMOS Logic Family Specifications"*.

Output capability: bus driver
I_{CC} category: MSI

AC CHARACTERISTICS FOR 74HC

GND = 0 V; $t_r = t_f$ = 6 ns; C_L = 50 pF

SYMBOL	PARAMETER	T_{amb} (°C)							UNIT	TEST CONDITIONS	
		74HC								V_{CC} (V)	WAVEFORMS
		+25			−40 to +85		−40 to +125				
		min.	typ.	max.	min.	max.	min.	max.			
t_{PHL}/ t_{PLH}	propagation delay CP to Q_n		47 17 14	150 30 26		190 35 33		225 45 38	ns	2.0 4.5 6.0	Fig.6
t_{PZH}/ t_{PZL}	3-state output enable time $\overline{OE}$ to Q_n		44 16 13	140 28 24		175 35 30		210 42 36	ns	2.0 4.5 6.0	Fig.7
t_{PHZ}/ t_{PLZ}	3-state output disable time $\overline{OE}$ to Q_n		39 14 11	125 25 21		155 31 26		190 38 32	ns	2.0 4.5 6.0	Fig.7
t_{THL}/ t_{TLH}	output transition time		14 5 4	60 12 10		75 15 13		90 18 15	ns	2.0 4.5 6.0	Fig.6
t_W	clock pulse width HIGH or LOW	80 16 14	14 5 4		100 20 17		120 24 20		ns	2.0 4.5 6.0	Fig.6
t_{su}	set-up time D_n to CP	60 12 10	6 2 2		75 15 13		90 18 15		ns	2.0 4.5 6.0	Fig.8
t_h	hold time D_n to CP	5 5 5	0 0 0		5 5 5		5 5 5		ns	2.0 4.5 6.0	Fig.8
f_{max}	maximum clock pulse frequency	6.0 30 35	37 112 133		4.8 24 28		4.0 20 24		MHz	2.0 4.5 6.0	Fig.6

DC CHARACTERISTICS FOR 74HCT

For the DC characteristics see *"74HC/HCT/HCU/HCMOS Logic Family Specifications"*.

Output capability: bus driver
I_{CC} category: MSI

Note to HCT types

The value of additional quiescent supply current (ΔI_{CC}) for a unit load of 1 is given in the family specifications. To determine ΔI_{CC} per input, multiply this value by the unit load coefficient shown in the table below.

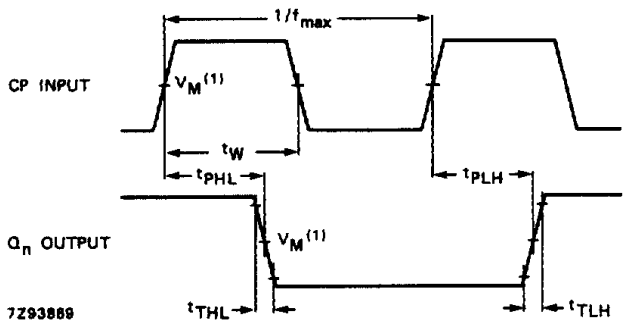
INPUT	UNIT LOAD COEFFICIENT
D_n	0.5
$\overline{OE}$	1.25
CP	1.5

AC CHARACTERISTICS FOR 74HCT

GND = 0 V; $t_r = t_f$ = 6 ns; C_L = 50 pF

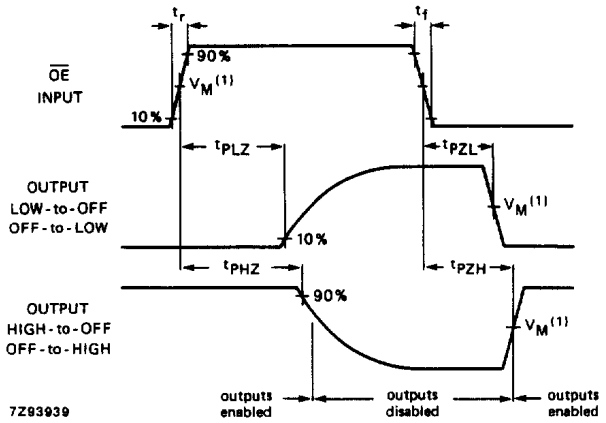
SYMBOL	PARAMETER	T_{amb} (°C)							UNIT	TEST CONDITIONS	
		74HCT								V_{CC} (V)	WAVEFORMS
		+25			−40 to +85		−40 to +125				
		min.	typ.	max.	min.	max.	min.	max.			
t_{PHL}/ t_{PLH}	propagation delay CP to Q_n		18	33		41		50	ns	4.5	Fig.6
t_{PZH}/ t_{PZL}	3-state output enable time $\overline{OE}$ to Q_n		19	33		41		50	ns	4.5	Fig.7
t_{PHZ}/ t_{PLZ}	3-state output disable time $\overline{OE}$ to Q_n		16	28		35		42	ns	4.5	Fig.7
t_{THL}/ t_{TLH}	output transition time		5	12		15		18	ns	4.5	Fig.6
t_W	clock pulse width HIGH or LOW	16	7		20		24		ns	4.5	Fig.6
t_{su}	set-up time D_n to CP	12	3		15		18		ns	4.5	Fig.8
t_h	hold time D_n to CP	5	−1		5		5		ns	4.5	Fig.8
f_{max}	maximum clock pulse frequency	30	69		24		20		MHz	4.5	Fig.6

AC WAVEFORMS



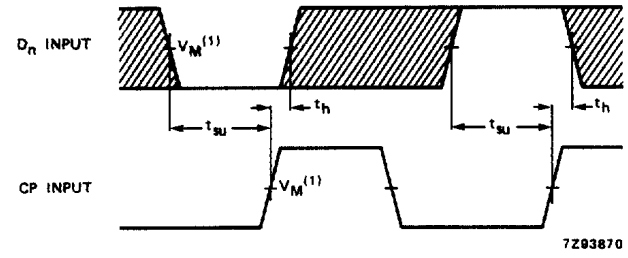
(1) HC : V_M = 50%; V_I = GND to V_{CC}.
HCT: V_M = 1.3 V; V_I = GND to 3 V.

Fig.6 Waveforms showing the clock input (CP) pulse width, the CP input to output (Q_n) propagation delays, the output transition times and the maximum clock pulse frequency.



(1) HC : V_M = 50%; V_I = GND to V_{CC}.
HCT: V_M = 1.3 V; V_I = GND to 3 V.

Fig.7 Waveforms showing the 3-state enable and disable times.



The shaded areas indicate when the input is permitted to change for predictable output performance.

(1) HC : V_M = 50%; V_I = GND to V_{CC}.
HCT: V_M = 1.3 V; V_I = GND to 3 V.

Fig.8 Waveforms showing the data set-up and hold times for D_n input to CP input.

PACKAGE OUTLINES

See *"74HC/HCT/HCU/HCMOS Logic Package Outlines"*.

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